

## SMD03 THRU SMD36 300W TVS DIODE

**RoHS Compliant Product** 

#### **FEATURES**

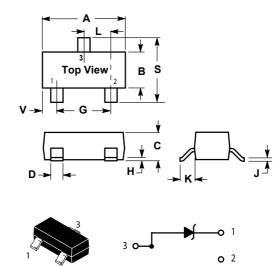
- · SC59 package for surface mount application
- Protects 3.3V up through 36V components
- · Protects two unidirectional line or one bidirection line
- · Provides electrically is olated protection
- ESD>10KV
- 300W Peak Power Protection( tp=8/2 us)

#### **MECHANICAL DATA**

- · Molded: SC59 Surface Mount
- · Body marked with marking code.
- · Mounting Position: Any
- Weight: 0.008 grams (approx.)

#### **APPLICATIONS**

- · Cellular Handsets and Accessories
- Portable Electronics
- · Industrial Controls
- · Set -Top Box
- · Servers, Notebook, and Desktop PC



SC-59						
Dim	Min Max					
Α	2.700	3.100				
В	1.500	1.700				
С	0.900	1.150				
D	0.350	0.500				
G	1.700	2.100				
Н	0.013	0.100				
J	0.100	0.200				
K	0.350	0.550				
L	0.900	1.000				
S	2.600	3.000				
٧	0.500 0.600					
All Dimension in mm						

### MAXIMUM RATING SAND ELECTRICAL CHARACTERISTICS

	Rating	Symbol	Value	Units
	Peak ulse Power (tp=8/20us)	P <sub>pk</sub>	300	Watts
	Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	556	°C/W
www.DataShe	eet4U.com Lead Soldering Temperature	TL	260 (10 sec.)	
	Operating Temperature	TJ	-55 to +125	
	Storage Temperature	T <sub>STG</sub>	-55 to +150	

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless otherwise specified

PART NUMBER	DEVICE MARKING	STAND OFF VOLTAGE V <sub>WM</sub> VOLTS	BREAKDOWN VOLTAGE V <sub>BR</sub> @1 mA VOLTS	CLAMPING VOLTAGE V <sub>C</sub> @ 1 Amp (FIGURE 2) VOLTS	CLAMPING VOLTAGE V <sub>C</sub> @ 5 Amp (FIGURE 2) VOLTS	LEAKAGE CURRENT Ι <sub>D</sub> @ V <sub>WM</sub> μΑ	CAPACITANCE @0V, 1 MHz C Pin 1-3 pF
			MIN	MAX	MAX	MAX	MAX
SMD03	X03	3.3	4-5	7	8.5	100	350
SMD05	X05	5.0	6.1-7.4	9.8	11	12	210
SMD12	X12	12.0	13.3-16.3	19	24	0.5	75
SMD15	X15	15.0	16.7-20.4	24	30	0.5	50
SMD24	X24	24.0	26.7-32.6	43	55	0.5	30
SMD36	X36	36.0	40.0-47.0	60	75	0.5	30

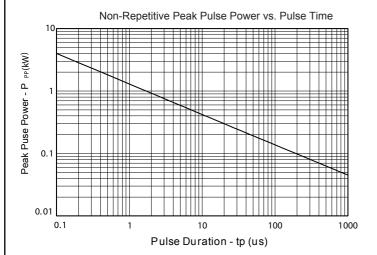
NOTE: Transient Voltage Suppression (TVS) product is normally selected based on its stand off Voltage Vwm. Product selected voltage should be equal to or greater than the continuous peak operating voltage of the circuit to be protected.

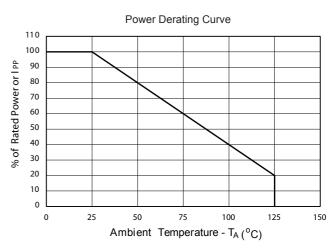
http://www.SeCoSGmbH.com

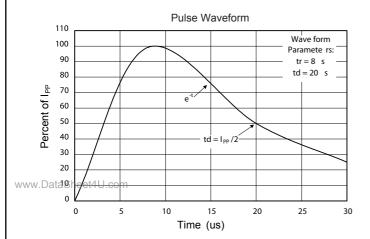
Any changing of specification will not be informed individual



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# **Applications Information Device Connection Options**

The SM series is designed to protect one unidirectional data or I/O lines operating at 5 to 36 volts. Connection options are as follows:

 Unidirectional:Data lines are connected to pin1 and Pin 3 is connected to ground.For best results,this pin should be connected directly to a ground plane on the board.The path lengh should be kept as short as possible to minimize parasitic inductance.

## Circuit Board Layout Recommendations for suppression of ESD.

Good circuit board layout is critical for the suppression of fast rise-time transients such as ESD. The following guidelines are recommended (Refer to application note SI99.01 for more detailed information):

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path toground should be kept as short as possible.
- · Never run critical signals near board edges
- · Use ground planes whenever possible.

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